

OVS5MxBCR4x Series

Features:

- Compact Package Outline of 3.25 mm x 3.2 mm
- · Robust energy-efficient design with long operating life
- Low thermal resistance
- · Exceptional spatial uniformity
- Compatible to IR reflow soldering
- High Lumens output



Description:

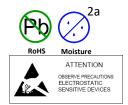
The mini-half watt is an energy-efficient packaged LED source that offers high luminance, and a long operating lifespan. This device offers a 115° viewing angle and an ultra-low profile (1.9 mm) making it highly suitable for conventional lighting and specialized applications.

Applications:

- Automotive exterior and interior lighting
- Architectural indoor and outdoor lighting
- General lighting
- Display Backlighting
- Electronic signs and signals

Optical Characteristics (T_A = 25° C unless otherwise noted)

PART NUMBER	VIEWING ANGLE	EMITTED COLOR	TYP LUMINOUS FLUX (lm)	FORWARD VOLTAGE V _F @ 140 mA	POWER DISSIPATION @ 150 mA	LENS COLOR	
OVS5MRBCR4A	MABCR4A 115° MABCR4B	Super Red (632 nm)	13.9	2.3	0.35 W	Class	
OVS5MABCR4A		Amber (624 nm)	23.5	2.3	0.35 W		
OVS5MABCR4B		Amber (615 nm)	26.8	2.3	0.35 W	Clear	
OVS5MYBCR4A		Yellow (589 nm)	23.5	2.3	0.35 W		



DO NOT LOOK DIRECTLY AT LED WITH UNSHIELDED EYES OR DAMAGE TO RETINA MAY OCCUR.



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Electrical Specifications

Absolute Maximum Ratings (T_A = 25° C unless otherwise noted)

	Red, Amber, Yellow
DC Forward Current	200 mA
Peak Pulsed Forward Current ¹	300 mA
Reverse Voltage	12 V @ 10 μA
Junction Temperature ²	125 ℃
Power Dissipation	750 mW
Operating Temperature	-40° ~ +115° C
Storage Temperature	-40° ~ +125° C
ESD (JEDEC-JESD22-A114F)	Class 2
MSL (IPC / JEDEC J-STD-020C)	2a / 672 Hrs
Thermal Resistance *	
Junction / Ambient, R _{th JA real}	110 K/W
Junction / Solder point R _{th JS real}	60 K/W
Electrical Thermal Resistance *	
Junction / Ambient, R _{th JA el}	100 K/W
Junction / Solder point R _{th JS el}	60 K/W

^{*} Mounted on FR4 PCB pad size >=16 mm² per pad

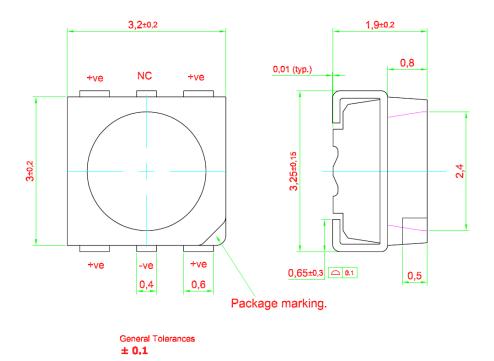




Electrical Specifications

Optical and Electrical Characteristics—Red, Amber, Yellow (I_F = 140 mA, T_A = 25° C)

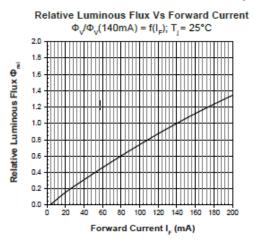
SYMBOL	PARAMETER			TYP	MAX	UNITS
V_{F}	Forward Voltage			2.6	2.5	V
Ф	Luminous Flux	Super Red (632nm)	9.35	13.9	20.6	- Im
		Amber (624nm)	18.1	23.5	30.6	
		Amber (615nm)	20.6	26.6	34.8	
		Yellow (589nm)	18.1	23.5	30.6	
λ		Red	627	633	639	nm
	Dominant Wavelength	Amber	612	619	627	
		Yellow	586	590	595	
I _R	Reverse Current @ 12 V			10		μΑ
2 0½	50% Power Angle			115		deg

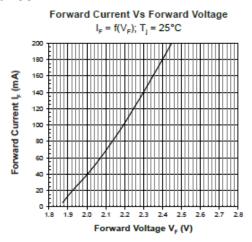


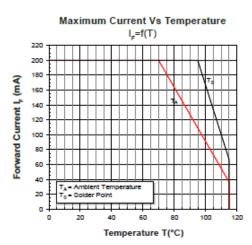


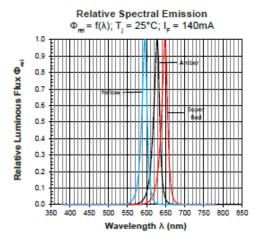


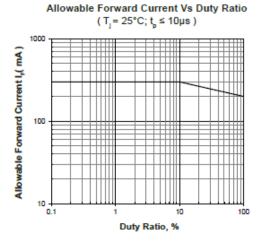
Performance

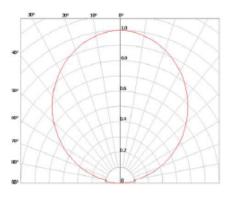












Radiation Pattern

General Note

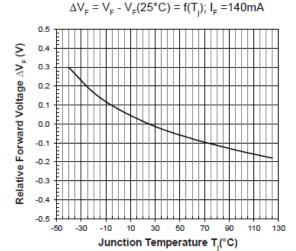
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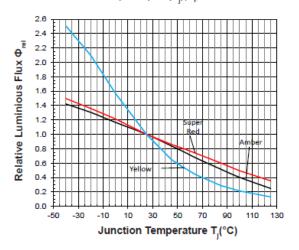


Performance

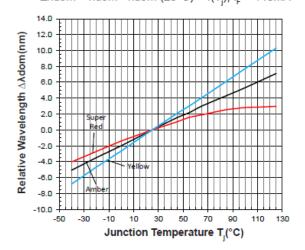
Relative Forward Voltage Vs Junction Temperature



Relative Luminious Flux Vs Junction Temperature $\Phi V/\Phi V(25^{\circ}C) = f(T_i); I_F = 140 \text{mA}$



Relative Wavelength Vs Junction Temperature $\Delta\lambda$ dom = λ dom - λ dom (25°C) = f(T_i); I_F = 140mA

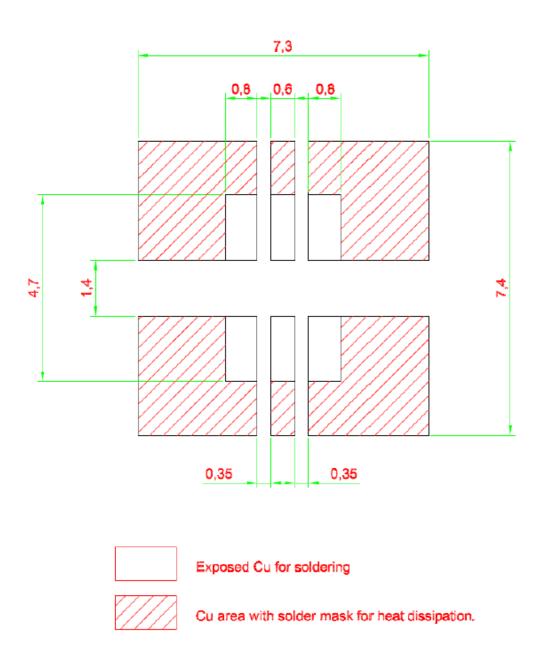




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Solder Pad Design

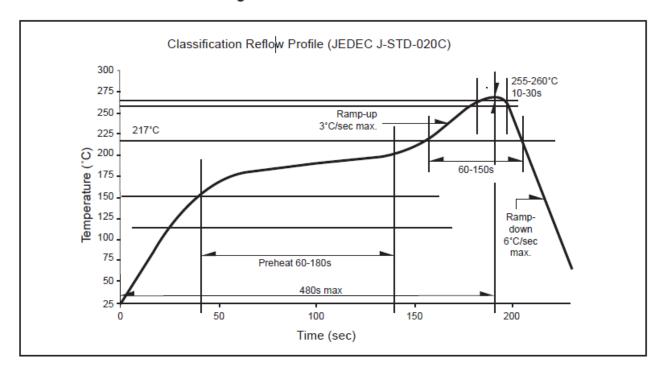
Note: Metal core circuit board (MCPCB) is highly recommended for high density applications. FR-4 board is recommended for other applications







Recommended Pb-free Soldering Profile

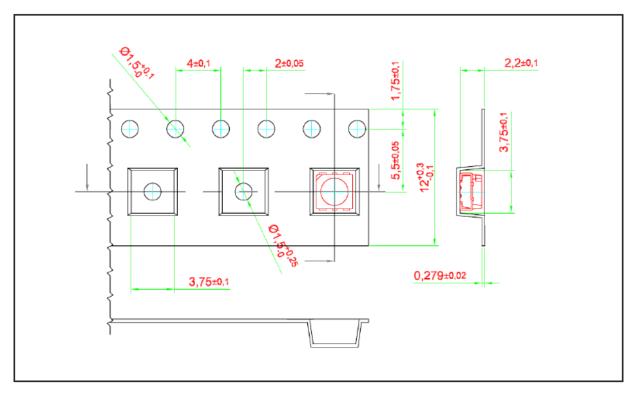




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Taping and orientation

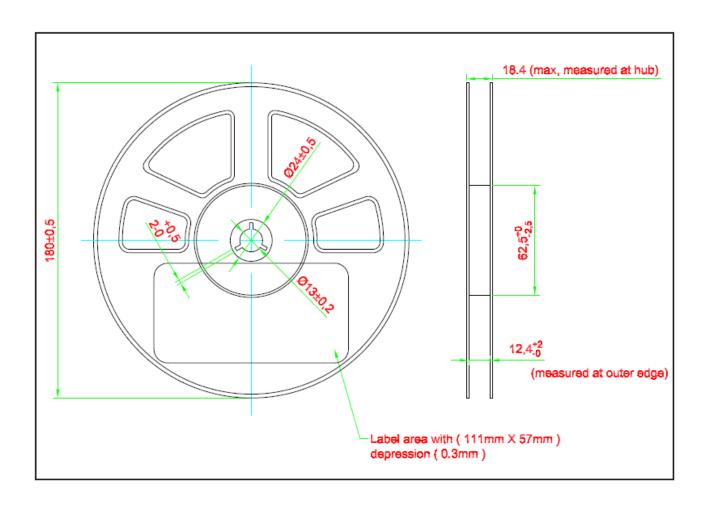
- · Reels come in quantity of 1000 units.
- · Reel diameter is 180 mm.





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Packaging Specification



Moisture Resistant Packaging

